

LAUNCHXL-F28379D Overview

The C2000™ LAUNCHXL-F28379D LaunchPad™ is a complete low-cost development board for the Texas Instruments Delfino™ F2837xD devices. The LAUNCHXL-F28379D kit features all the hardware and software necessary to develop applications based on the F2837xD microcontrollers. This LaunchPad is based on the superset F28379D device, and easily allows users to migrate to lower feature set and/or lower pin count F2837x devices once the design needs are known. It offers an on-board JTAG debug tool allowing direct interface to a PC for easy programming, debugging, and evaluation. In addition to JTAG emulation, the USB interface provides a UART serial connection from the F28379D device to the host PC.

Contents

1	Introduction	2
2	Kit Contents.....	3
3	Installation	4
4	Getting Started With the LAUNCHXL-F28379D	5
5	Hardware Configuration.....	5
6	LAUNCHXL-F28379D Hardware	8
7	References	26
8	Frequently Asked Questions (FAQ).....	27

List of Figures

1	LAUNCHXL-F28379D Board Overview	3
2	P01_Block Diagram.....	10
3	P02_XDS100v2.....	11
4	P03_Power	12
5	P04_ADCIND	13
6	P05_PWM-DAC	13
7	P06_BoosterPack Headers	14
8	P07_F28379D-PWR	14
9	P08_F28379D-IO1	15
10	P09_F28379_IO2	16
11	P10_EX-Headers.....	17
12	Top	18
13	GND.....	18
14	Route1	18
15	Route2	18
16	VDD	18
17	Bottom	18
18	Top Silkscreen Overlay.....	18
19	Bottom Silkscreen Overlay	18
20	Top Pad Master	19
21	Bottom Pad Master.....	19

List of Tables

1	Supplying the LaunchPad With 3.3 V	6
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2	Supplying the LaunchPad With 5 V	6
3	Positions of Signals Present on Switch S1	7
4	Revision 2.0: Resistor Selection for Routing Dual-Mapped Signals	7
5	F28379D LaunchPad Pin Out and Pin Mux Options - J1, J3	8
6	F28379D LaunchPad Pin Out and Pin Mux Options - J4, J2	8
7	F28379D LaunchPad Pin Out and Pin Mux Options - J5, J7	9
8	F28379D LaunchPad Pin Out and Pin Mux Options - J8, J6	9
9	LAUNCHXL-F28379D Bill of Materials	20

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1 Introduction

Users can download an unrestricted copy of the latest version of Code Composer Studio™ IDE to write, download, and debug applications on the LAUNCHXL-F28379D board. The debugger is unobtrusive, allowing the user to run an application at full speed with hardware breakpoints and available single step execution while consuming no extra hardware resources.

As shown in [Figure 1](#), the LAUNCHXL-F28379D LaunchPad features include:

- USB debugging and programming interface via a high-speed galvanically isolated XDS100v2 debug probe featuring a USB/UART connection
- Superset TMS320F28379D device
- Two user LEDs
- Device reset pushbutton
- Easily accessible device pins for debugging purposes or as sockets for adding customized extension boards
- Dual 5 V quadrature encoder interfaces
- CAN Interface with integrated transceiver
- Boot selection switches
- Differential Amplifier to provide buffered signals to ADCD for 16-bit mode
- Optional SMA connection points P/N:SMA-J-P-H-ST-EM1
- Four Sigma Delta demodulator inputs brought to the BP headers

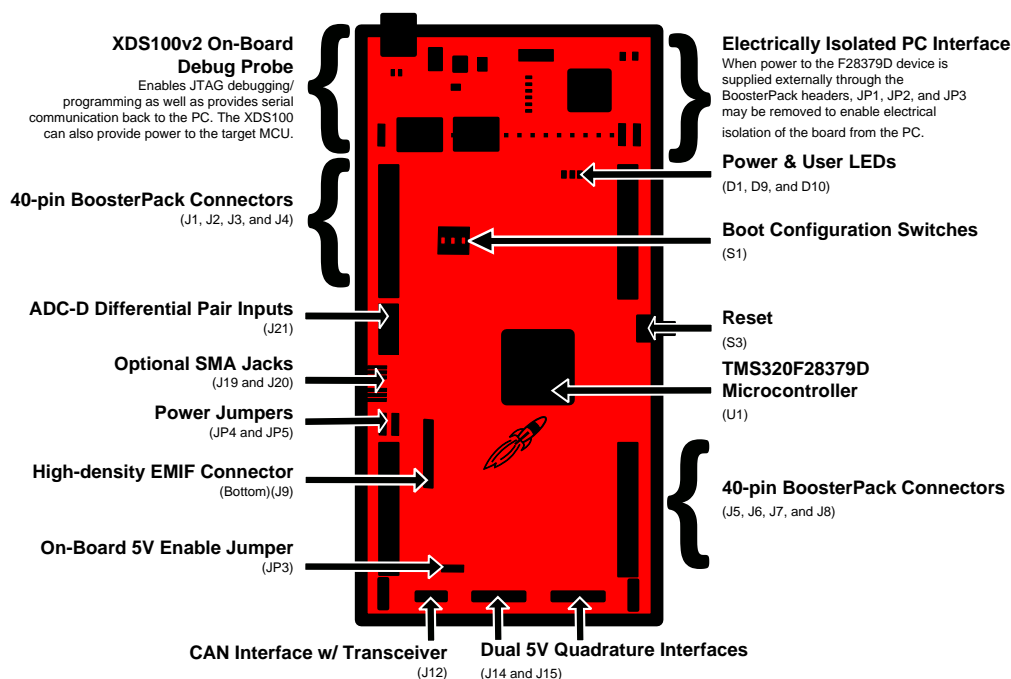


Figure 1. LAUNCHXL-F28379D Board Overview

2 Kit Contents

The LAUNCHXL-F28379D LaunchPad kit includes the following items:

- C2000 Delfino LaunchPad Board (LAUNCHXL-F28379D)
- Mini USB-B Cable, 0.5m
- Quick Start Guide

2.1 Revisions

The first production revision of the LAUNCHXL-F28379D in 2016 was Revision 1.1. In late 2017 the LAUNCHXL-F28379D revision changed from 1.1 to 2.0 to fix various issues and make improvements to the design.

Revision 1.1:

- ADCINA2 is shorted to VREFHIB. It is recommended that users avoid using the ADCINA2 channel.
- The VIN+ signal of component U1 may be shorted to ADCINB4 and/or ADCINC4 due to variance in manufacturing tolerances. No issues have been reported, but the clearances violate manufacturing rules and a short may occur.
- The silkscreen for the ADC channels on J3 and J7 are mixed up and some may be incorrect. Reference the schematic for the proper pin positions.
- J3 and J7 connectors are labeled incorrectly on the backside silkscreen. Refer the the Rev 1.1 schematic for the proper signal locations on the connector

Revision 2.0:

A revision was made to resolve the layout issues present on revisions 1.1. In addition to the fixes for aforementioned issues, additional changes were made to the schematic and layout to improve available features and increase usability.

- User LEDs and current limiting resistor values were changed to prevent the LEDs from being too bright to look at directly.
- The CAN signal header J12 was shifted towards the center of the board and the silkscreen properly aligned. PGND was removed and replaced with GND for the proper grounding of the CAN signals.
- J11 and J13 were removed and replaced with a 0 Ω resistor selection tree for routing between the BoosterPack headers and the backside high-density connector J9. For more information on how to configure these resistors for the desired routing, see [Section 5.5](#).
- Additional EMIF1 signals were routed to J9 to enable SDRAM support. These signals are also routed to the BoosterPack headers. As such, these signals have a resistor selection network for routing the signals to either the BoosterPack headers, J9 or both. For the information on how to configure these resistors for the desired routing, see [Section 5.5](#).
- An additional jumper, J16, was added to the lower left corner of the board for an additional connection point for supplying +5 V externally.
- ADC input signal conditioning circuit was updated for proper operation under additional operating conditions. C4 is now 180 pF; R60/R61 are changed to 10k- Ω and are placed between the VOUT signal of U13 to the VOCM of U1.
- Backside silkscreen for J3 and J7 have been corrected and reflect the proper signals at the noted location on the connector.

3 Installation

The F28379D LaunchPad is supported in Code Composer Studio.

3.1 Code Composer Studio

3.1.1 Download the Required Software

Code Composer Studio IDE is available for free without any restriction when used with the XDS100v2 debug probe on the C2000 LaunchPad. The software can be downloaded from the C2000 LaunchPad page at ti.com/launchpad. At this site, you can also download a copy of c2000Ware that includes drivers, examples, and other support software needed to get started.

3.1.2 Install the Software

Once downloaded, install Code Composer Studio and the C2000Ware package.

3.1.3 Install the Hardware

After Code Composer Studio is installed, plug the supplied USB cable into the C2000 LaunchPad board and into an available USB port on your computer.

Windows® will automatically detect the hardware and ask you to install software drivers. Let Windows run a search for the drivers and automatically install them. After Windows successfully installs the drivers for the integrated XDS100v2 debug probe, your LaunchPad is now ready for use.

4 Getting Started With the LAUNCHXL-F28379D

4.1 Getting Started

The first time the LAUNCHXL-F28379D board is powered-on a demo application will automatically start. Connect the LAUNCHXL-F28379D to a free USB port using the included mini-USB cable. The demo application will start with LEDs D9 and D10 blinking to show the device is active. If your board does not start the demo application, try setting switch S1 in the following positions and resetting the board: 1-UP, 2-UP, 3-DOWN.

4.2 Demo Application, ADC Sampling

The LAUNCHXL-F28379D includes a pre-programmed TMS320F28379D device. When the LaunchPad is powered via USB, the demo starts with an LED blink sequence. After a few seconds the device switches into an ADC sample mode.

Every 1 second the ADC samples pin ADCIN14 and the sampled data is represented as follows: If the sample is above mid-scale (2048), the blue LED D10 will illuminate. If the sample is below mid-scale, the red LED D9 will illuminate.

In addition to the LED indicators, ADC sample information is also displayed on your PC through the USB/UART connection. To view the UART information on your PC, first determine the COM port associated with the LaunchPad. To do this in Windows, right click on *My Computer* and click on *Properties*. In the dialog box that appears, click on the *Hardware* tab and open *Device Manager*. Look for an entry under *Ports (COM & LPT)* titled "USB Serial Port (COMX)", where X is a number. Remember this number for when you open a serial terminal. The demo applications UART data was written and debugged using PuTTY, and for the best user experience we recommend you use PuTTY to view the UART data. PuTTY can be downloaded from the following URL:

<http://www.chiark.greenend.org.uk/~sgtatham/putty/download.html>

Open your serial terminal program and open the COM port you found previously in device manager with the following settings: 115200 Baud, 8 data bits, no parity, 1 stop bit. After opening the serial port in your serial terminal, reset the LaunchPad with the reset push button S3 and observe the serial terminal to see the TI logo in ASCII art.

4.3 Program and Debug the ADC Sample Demo Application

The project and associated source code for the C2000 Delfino LaunchPad demo is included in the C2000Ware software package and should automatically be found by the TI Resource Explorer in Code Composer Studio. In the resource explorer, navigate C2000Ware to find the *device_support\2837x\examples* folder. Expand this item and LAUNCHXL-F28379D, then select the LaunchPad Demo Application. Follow the steps in the main pane of the resource explorer to import, build, debug, and run this application.

5 Hardware Configuration

The F28379D LaunchPad provides users with several options for configuring the board.

5.1 ADC Resolution

The F28379D had 4 independent 16-bit/12-bit ADCs. The resolution of each ADC is SW selectable. ADCA, ADCB, and ADCC are all routed to the BoosterPack headers for use with different booster packs. Most BoosterPacks will use the ADC in 12-bit mode which supports Single Ended (SE) inputs. ADCD has been routed to a special side connector with ability to drive through a differential amplifier to support 16-bit mode with Differential Ended (DE) inputs.

5.2 Power Domain

The LaunchPad has several different power domains to enable JTAG Isolation. Jumpers JP1, JP2, JP3 control JTAG Isolation, supply GND, 3.3 V and 5 V to the rest of the board. There are also other jumpers that provide different methods for powering the device.

[Table 1](#) describes the different methods by which 3.3 V can be supplied to the device. It can be derived from USB in configuration 1. Here, the on-board regulator steps the 5 V from the USB port down to 3.3 V to be used by the XDS100v2 debug probe as well as connected to the device side of the LaunchPad through JP1. Configuration 1 is a non-isolated configuration. Alternately, in configuration 2 the debugger and USB connection are isolated from the device. The 3.3 V source must be provided externally through the BoosterPack headers or through J10.

Table 1. Supplying the LaunchPad With 3.3 V

Configuration	JP1	JP2	USB	External 3.3 V	JTAG/USB Isolation Status
1	Yes	Yes	Yes	No	Not Isolated
2	No	No	Don't Care	Yes	Isolated

The LaunchPad also has a 5 V power rail. It can be supplied directly from the USB (not isolated) generated from a 3.3 V to 5 V step-up regulator through JP6, or supplied externally through the BoosterPack Headers or J16. [Table 2](#) describes these various configurations.

The debug probe and USB are not isolated in configuration 1 since JP2 and JP3 are connected. The 5 V supply is coming from the USB directly to the device side of the LaunchPad and can be used to power other devices connected to the BoosterPack headers. In this configuration, do not connect JP6 as there may be contention between the 5 V from the USB (JP3) and the 5 V from the on-board step-up regulator, U12.

Configuration 2 is an isolated configuration where 3.3 V is supplied any way other than through JP1. In this configuration, JP6 is connected allowing the 3.3 V to be stepped up to 5 V with the on-board step-up regulator, U12. In this configuration ensure that no other 5 V source is connected to the BoosterPack headers or through J16.

Configuration 3 is another isolated configuration since JP2 and JP3 are not connected. With JP6 disconnected, 5 V must be supplied through an external connection on the BoosterPack headers or J16. Notice that this configuration does not rely on the 3.3 V supply being powered to provide the 5 V. To supply 3.3 V to the device in an isolated configuration, see [Table 1](#).

Table 2. Supplying the LaunchPad With 5 V

Configuration	JP2	JP3	JP6	External 5 V	USB	JTAG/USB Isolation Status
1	Yes	Yes	No	No	Yes	Not Isolated
2	No	No	Yes	No	Don't Care	Isolated
3	No	No	No	Yes	Don't Care	Isolated

5.3 Boot Mode Selection

The LaunchPad's F28379D device includes a boot ROM that performs some basic start-up checks and allows for the device to boot in many different ways. Most users will either want to perform an emulation boot or a boot to flash (if they are running the application standalone). Switch S1 has been provided to allow users to easily configure the pins that the bootROM checks to make this decision. The positions on S1 correspond to those shown in [Table 3](#).

Table 3. Positions of Signals Present on Switch S1

Positions	Function
1	GPIO84
2	GPIO72
3	TRSTn

Keep in mind that the debug probe does not connect if the device is not in the emulation boot mode (TRST switch in the UP-1 position). More information about boot mode selection can be found in the *Boot ROM* section of the [TMS320F2837xD Dual-Core Delfino Microcontrollers Technical Reference Manual](#).

5.4 Connecting a BoosterPack

The F2837xD LaunchPad is the perfect experimenter board to start hardware development with the F2837xD devices. All of the connectors are aligned in a 0.1-in (2.54-mm) grid to allow easy and inexpensive development of add on boards called BoosterPacks. These satellite boards can access all of the GPIO and analog signals. The pinout of the connectors can be found in [Section 5](#).

5.5 GPIO Routing Between BoosterPack and I/O Expansion Headers

This LaunchPad has a high-density connector (J9) on the backside of the board. This connector provides for an IO expansion board to be connected. Many of the EMIF1 signals are available as well as SPI and I2C. Some of the signals present on J9 are also available on the BoosterPack expansion headers.

On Revision 1.x LaunchPads, only two signals were dual-mapped to both J9 and the BoosterPack Headers, GPIO40 and GPIO41. To select the destination, the three-position jumpers, J11 and J13, could be adjusted accordingly. Placing the jumper between position 1 and position 2 will route the signal to J9. Placing the jumper between position 2 and position 3 will route the signal to the BoosterPack headers.

On revision 2.0 LaunchPads, in addition to GPIO40 and GPIO41, four more signals may be routed to either the BoosterPack headers or J9 independently, or may be connected to both based on the placement of 0Ω resistors. By default, the signals are only routed to the BoosterPack headers for alignment with the BoosterPack standards. [Table 4](#) provides the mapping for each signal and which resistors populate in order to route the signal as desired. Refer to the schematic at the end of this document in [Section 6.2](#), or located in the C2000Ware directory.

Table 4. Revision 2.0: Resistor Selection for Routing Dual-Mapped Signals

GPIO	Route to BoosterPack Headers	Route to J9 Header
GPIO29	R75	R76
GPIO40	R67	R68
GPIO41	R69	R70
GPIO52	R77	R78
GPIO104	R71	R72
GPIO105	R73	R74

6 LAUNCHXL-F28379D Hardware

6.1 Device Pin Out

Table 5 through Table 8 lists the pin out and pin mux options for the C2000 LaunchPad. Additional muxing options are available and can be found in the [TMS320F2837xD Dual-Core Delfino™ Microcontrollers Data Manual](#).

Table 5. F28379D LaunchPad Pin Out and Pin Mux Options - J1, J3

Mux Value				J1 Pin	J3 Pin	Mux Value			
X	2	1	0			0	Alt Function	2	X
			3.3V	1	21	5V			
			GPIO32	2	22	GND			
	SCIRXDB		GPIO19	3	23	ADCIN14	CMPIN4P		
	SCITXDB		GPIO18	4	24	ADCINC3	CMPIN6N		
			GPIO67	5	25	ADCINB3	CMPIN3N		
			GPIO111	6	26	ADCINA3	CMPIN1N		
SPICLKA ⁽¹⁾			GPIO60	7	27	ADCINC2	CMPIN6P		
			GPIO22	8	28	ADCINB2	CMPIN3P		
		SCLA	GPIO105 ⁽²⁾	9	29	ADCINA2	CMPIN1P		
		SDAA	GPIO104 ⁽²⁾	10	30	ADCINA0	DACOUTA		

⁽¹⁾ For full pin muxing table for functions shown here and additional mux options, see the [TMS320F2837xD Dual-Core Delfino™ Microcontrollers Data Manual](#).

⁽²⁾ This signal is also routed to the IO expansion header, J9. For information on how to configure this signal, see [Section 5.5](#).

Table 6. F28379D LaunchPad Pin Out and Pin Mux Options - J4, J2

Mux Value				J4 Pin	J2 Pin	Mux Value			
X	2	1	0			0	1	2	X
		EPWM1A	GPIO0	40	20	GND			
		EPWM1B	GPIO1	39	19	GPIO61			
		EPWM2A	GPIO2	38	18	GPIO123			SD1_C1 ⁽¹⁾
		EPWM2B	GPIO3	37	17	GPIO122			SD1_D1 ⁽¹⁾
		EPWM3A	GPIO4	36	16	RST			
		EPWM3B	GPIO5	35	15	GPIO58			SPISIMOA ⁽¹⁾
		OUTPUTXBAR1	GPIO24	34	14	GPIO59			SPISOMIA ⁽¹⁾
OUTPUTXBAR7 ⁽¹⁾			GPIO16	33	13	GPIO124			SD1_D2 ⁽¹⁾
			DAC1	32	12	GPIO125			SD1_C2 ⁽¹⁾
			DAC2	31	11	GPIO29 ⁽²⁾			OUTPUTXBAR6 ⁽¹⁾

⁽¹⁾ For full pin muxing table for functions shown here and additional mux options, see the [TMS320F2837xD Dual-Core Delfino™ Microcontrollers Data Manual](#).

⁽²⁾ This signal is also routed to the IO expansion header, J9. For information on how to configure this signal, see [Section 5.5](#).

Table 7. F28379D LaunchPad Pin Out and Pin Mux Options - J5, J7

Mux Value				J5 Pin	J7 Pin	Mux Value			
X	2	1	0			0	Alt Function	2	X
			3.3V	41	61	5V			
			GPIO95	42	62	GND			
SCIRXDC ⁽¹⁾			GPIO139	43	63	ADCIN15	CMPIN4N		
SCITXDC ⁽¹⁾			GPIO56	44	64	ADCINC5	CMPIN5N		
			GPIO97	45	65	ADCINB5			
			GPIO94	46	66	ADCINA5	CMPIN2N		
SPICLKB ⁽¹⁾			GPIO65	47	67	ADCINC4	CMPIN5P		
			GPIO52 ⁽²⁾	48	68	ADCINB4			
SCLB ⁽¹⁾			GPIO41 ⁽²⁾	49	69	ADCINA4	CMPIN2P		
SDAB ⁽¹⁾			GPIO40 ⁽²⁾	50	70	ADCINA1	DACOUTB		

⁽¹⁾ For full pin muxing table for functions shown here and additional mux options, see the [TMS320F2837xD Dual-Core Delfino™ Microcontrollers Data Manual](#).

⁽²⁾ This signal is also routed to the IO expansion header, J9. For information on how to configure this signal, see [Section 5.5](#).

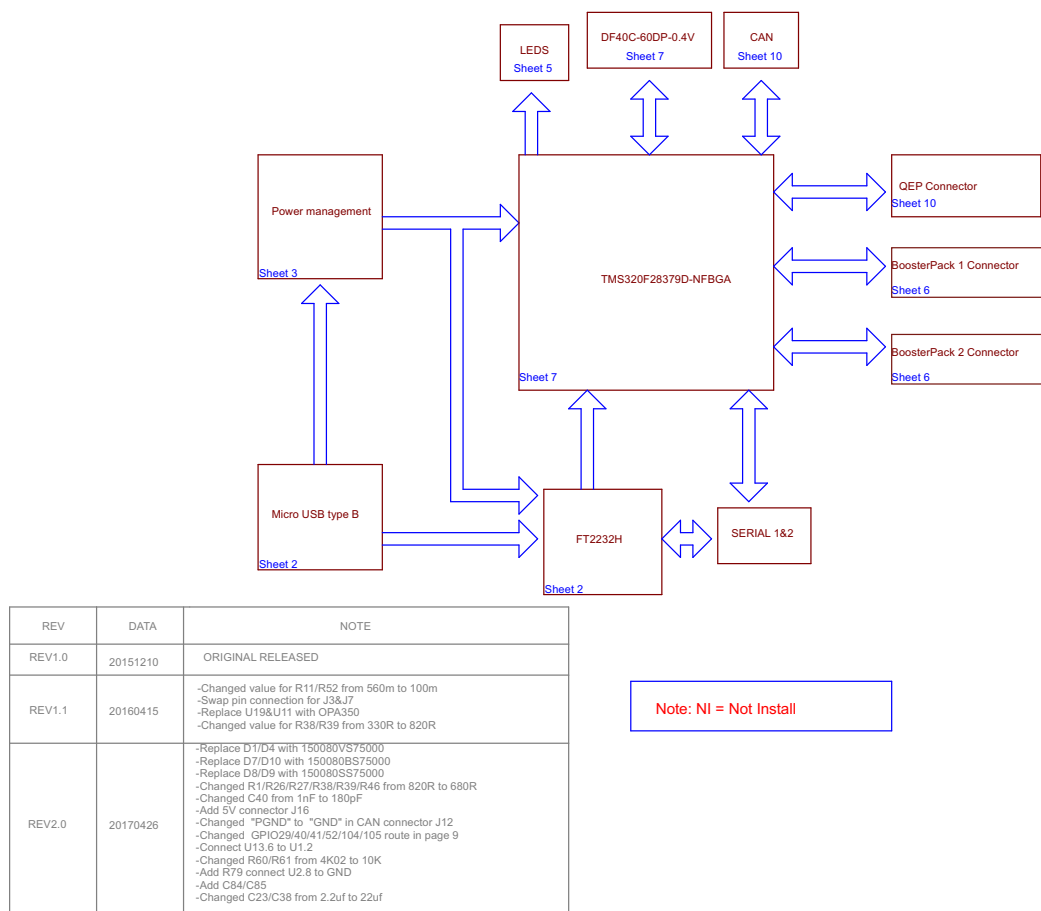
Table 8. F28379D LaunchPad Pin Out and Pin Mux Options - J8, J6

Mux Value				J8 Pin	J6 Pin	Mux Value			
X	2	1	0			0	1	2	X
		EPWM4A	GPIO6	80	60	GND			
		EPWM4B	GPIO7	79	59	GPIO66			
		EPWM5A	GPIO8	78	58	GPIO131			SD2_C1 ⁽¹⁾
		EPWM5B	GPIO9	77	57	GPIO130			SD2_D1 ⁽¹⁾
		EPWM6A	GPIO10	76	56	RST			
		EPWM6B	GPIO11	75	55	GPIO63			SPISIMOB ⁽¹⁾
OUTPUTXBAR3 ⁽¹⁾			GPIO14	74	54	GPIO64			SPISOMIB ⁽¹⁾
OUTPUTXBAR4 ⁽¹⁾			GPIO15	73	53	GPIO26			SD2_D2 ⁽¹⁾
			DAC3	72	52	GPIO27			SD2_C2 ⁽¹⁾
			DAC4	71	51	GPIO25			OUTPUTXBAR2 ⁽¹⁾

⁽¹⁾ For full pin muxing table for functions shown here and additional mux options, see the [TMS320F2837xD Dual-Core Delfino™ Microcontrollers Data Manual](#).

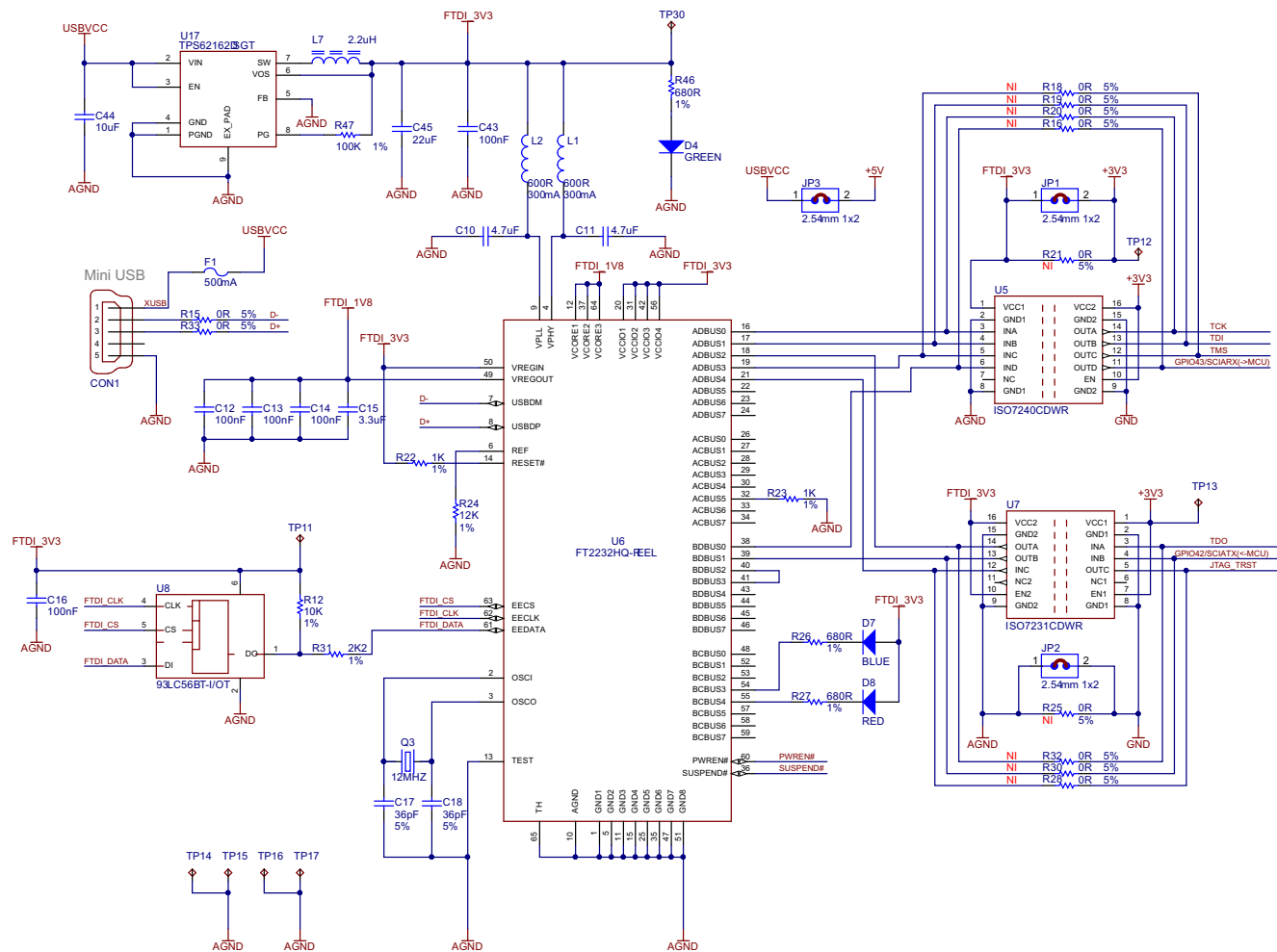
6.2 Schematics

The following figures show the LAUNCHXL-F28379D Rev 2.0 schematic. The schematics for both LAUNCHXL-F28379D Revision 2.0 and Revision 1.1 are located in C2000Ware.



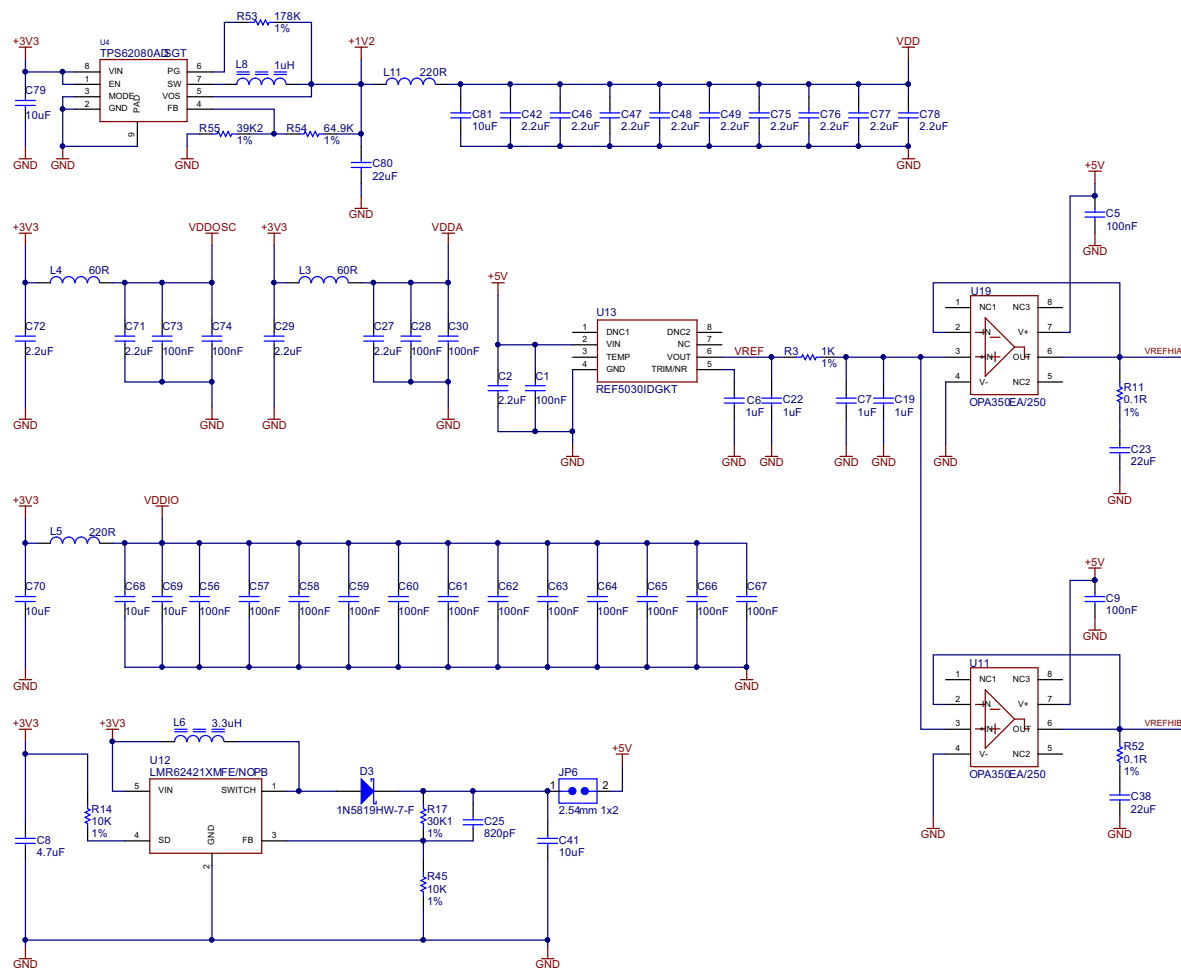
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Figure 2. P01_Block Diagram



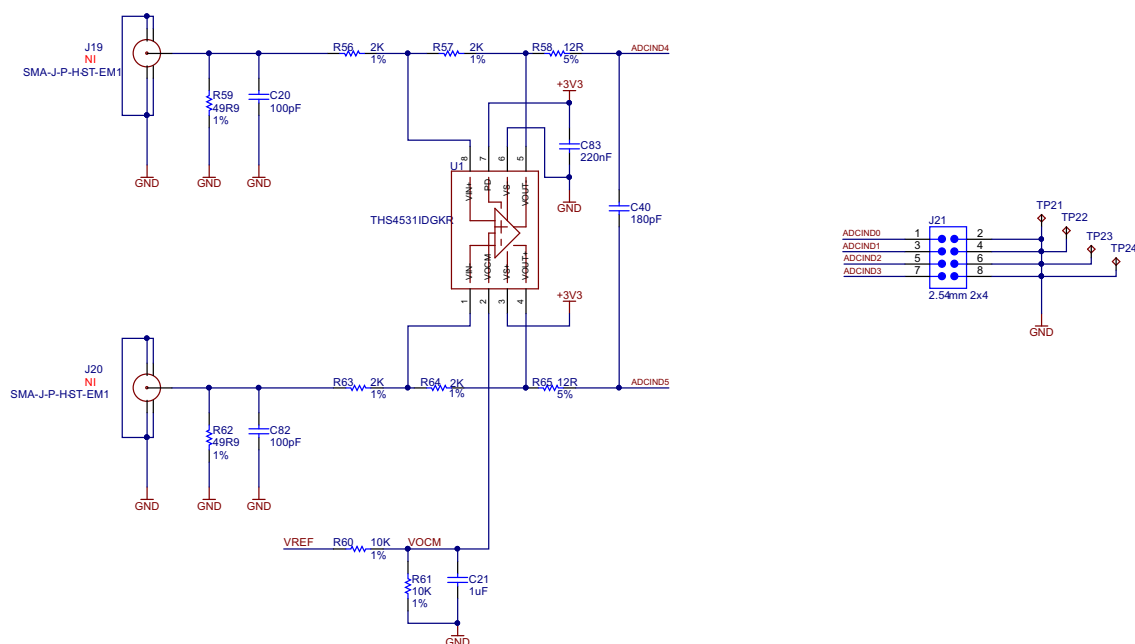
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Figure 3. P02_XDS100v2



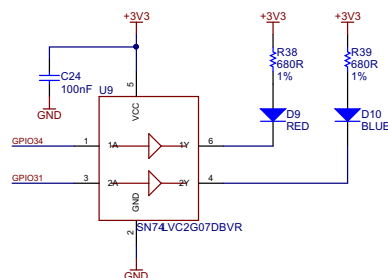
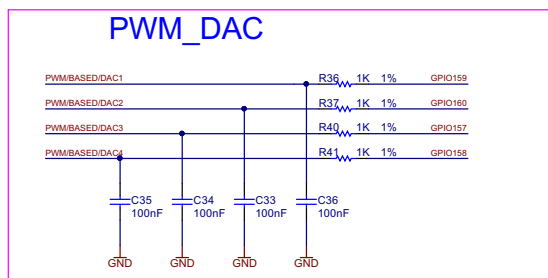
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Figure 4. P03_Power



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Figure 5. P04_ADCIND



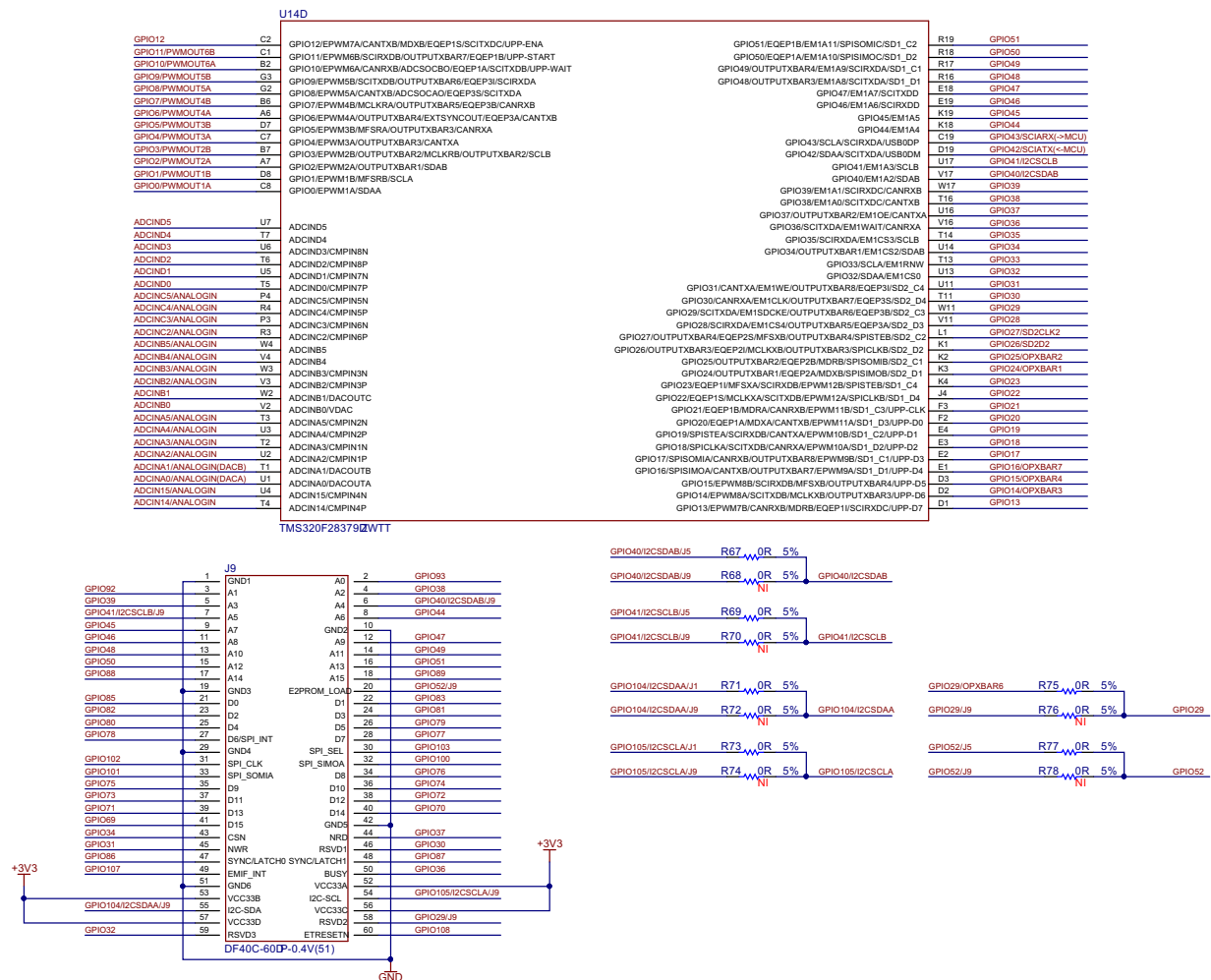
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Figure 6. P05_PWM-DAC

U14C			
GPIO135	U18	GPIO135/SCITXDA/SD2_C1	GPIO52/EQEP15/EM1A12/SPICLK/SD1_D1
GPIO134	V18	GPIO134/SD2_D1	GPIO53/EQEP1/EM1D31/EM2D15/SPISTEC/SD1_C1
GPIO133	G18	GPIO133/SAUXCLKIN/SD2_C1	GPIO54/SPISMOA/EM1D30/EM2D14/EQEP2A/SCITXDB/SD1_D1
GPIO132	W18	GPIO132/SD2_D1	GPIO55/SPISMOA/EM1D28/EM2D13/EQEP2B/SCITXDB/SD1_C1
GPIO131/SD2CLK1	V10	GPIO131/SD2_C2	GPIO56/SPICLK/EM1D28/EM2D12/EQEP23/SCITXDC/SD2_D2
GPIO130/SD2D1	T10	GPIO130/SD2_D2	GPIO57/SPISTEA/EM1D27/EM2D11/EQEP23/SCITXDC/SD2_C2
GPIO129	T10	GPIO129/SD1_C1	GPIO58/MCLKRA/EM1D26/EM2D10/OUTPUTXBAR1/SPICLK/SD2_D2/SPISMOA1
GPIO128	W9	GPIO128/SD1_D1	GPIO59/MF SRA/EM1D25/EM2D9/OUTPUTXBAR2/SPISTEB/SD2_C2/SPISMOA1
GPIO127	V9	GPIO127/SD1_C1	GPIO60/MCLKRB/EM1D24/EM2D8/OUTPUTXBAR3/SPISMOB/SD2_D3/SPICLK1
GPIO126	U9	GPIO126/SD1_D1	GPIO61/MFSRB/EM1D23/EM2D7/SPISOMIB/SD2_C3/SPISTEA1
GPIO125/SD1CLK2	T9	GPIO125/SPISTEC/SD1_C1	GPIO62/SCITXDC/EM1D22/EM2D6/EQEP3A/CANRXA/SD2_D1
GPIO124/SD1D2	V8	GPIO124/SPICLK/SD1_D1	GPIO63/SCITXDC/EM1D21/EM2D5/EQEP3B/CANTXA/SD2_C4/SPISMOB1
GPIO123/SD1CLK1	U8	GPIO123/SPISOMIC/SD1_C2	GPIO64/EM1D20/EM2D4/EQEP33/SCITXDA/SPISOMIB1
GPIO122/SD1D1	T8	GPIO122/SPISOMOC/SD1_D2	GPIO65/EM1D19/EM2D3/EQEP33/SCITXDA/SPICLK1
GPIO121	W18	GPIO121/EM2D0E/US80EPEN1	GPIO66/EM1D18/EM2D2/SDAB/SPISTEB1
GPIO120	U15	GPIO120/EM2D0E/US80PFLT1	GPIO67/EM1D17/EM2D2
GPIO119	T15	GPIO119/EM2D0RW1	GPIO68/EM1D16/EM2D1
GPIO118	T12	GPIO118/EM2CLK1	GPIO69/EM1D15/CLBL/SPISOMOC1
GPIO117	U12	GPIO117/EM2DCKE1	GPIO70/EM1D14/CANRXA/SCITXDB/SPISOMIC1
GPIO116	W10	GPIO116/EM2CS1	GPIO71/EM1D13/CANTXA/SCITXDB/SPICLK1
GPIO115	V12	GPIO115/EM2CS1	GPIO72/EM1D12/CANTXB/SCITXDC/SPISTEC1
GPIO114	N3	GPIO114/EM2GRAS1	GPIO73/EM1D11/XCLKOUT/CANRXB/SCITXDC1
GPIO113	N4	GPIO113/EM2CAS1	GPIO74/EM1D10
GPIO112	M3	GPIO112/EM2BA2	GPIO75/EM1D9
GPIO111	M4	GPIO111/EM2BA1	GPIO76/EM1D8/SCITXDD1
GPIO110	M2	GPIO110/EM2WAIT1	GPIO77/EM1D7/SCITXDD1
GPIO109	N2	GPIO109/EM2A1	GPIO78/EM1D6/EQEP2A1
GPIO108	L4	GPIO108/EM2A1	GPIO79/EM1D5/EQEP2B1
GPIO107	L3	GPIO107/EM2A/SCITXDC1	GPIO80/EM1D4/EQEP2B1
GPIO106	L2	GPIO106/EM2A/EQEP33/SCITXDC1	GPIO81/EM1D3/EQEP2B1
GPIO105/SC2CLA	J3	GPIO105/SC2CLA/EM2A7/EQEP3B/SCITXDD1	GPIO82/EM1D2
GPIO104/SC2SDAA	J2	GPIO104/SC2SDAA/EM2A6/EQEP3A/SCITXDD1	GPIO83/EM1D1
GPIO103	J1	GPIO103/EM2A5/EQEP23/SPISTEC1	GPIO84/SCITXDA/MDXB/MDXA1
GPIO102	H3	GPIO102/EM2A4/EQEP23/SPICLK1	GPIO85/EM1D0/SCITXDA/MDRB/MDRA1
GPIO101	H2	GPIO101/EM2A3/EQEP23/SPISOMIC1	GPIO86/EM1A13/EM1CA3/SCITXDB/MCLKB/MCLKA1
GPIO100	H1	GPIO100/EM2A2/EQEP2A/SPISOMOC1	GPIO87/EM1A14/EM1RAS/SCITXDB/MFSXB/MFSXA1
GPIO99	G1	GPIO99/EM2A1/EQEP11	GPIO88/EM1A15/EM1DOM1
GPIO98	F1	GPIO98/EM2A0/EQEP151	GPIO89/EM1A16/EM1DOM1/SCITXDC1
GPIO97	A2	GPIO97/EM2DOM0/EQEP1B1	GPIO90/EM1A17/EM1DOM2/SCITXDC1
GPIO96	C3	GPIO96/EM2DOM1/EQEP1A1	GPIO91/EM1A18/EM1DOM3/SDA1
GPIO95	B3	GPIO95	GPIO92/EM1A19/EM1BA1/SCLA1
			GPIO93/EM1BA0/SCITXDD1
			GPIO94/SCITXDD1
TMS20F28379QWTT			

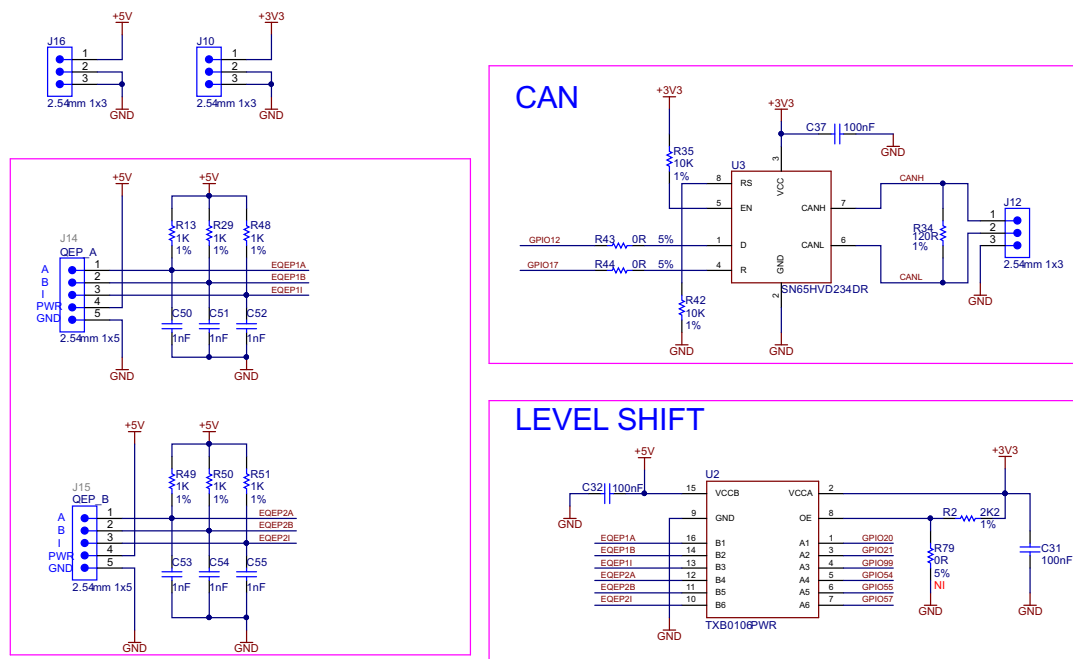
GPIO136	T17	GPIO136/SCITXDA/SD2_D4	GPIO153
GPIO137	T18	GPIO137/SCITXDB/SD2_C4	GPIO154
GPIO138	T19	GPIO138/SCITXDB	GPIO155
GPIO139/SCITXDC	N19	GPIO139/SCITXDC	GPIO156
GPIO140	M19	GPIO140/SCITXDC	GPIO157
GPIO141	M18	GPIO141/SCITXDC	GPIO158
GPIO142	L19	GPIO142/SCITXDC	GPIO159
GPIO143	F18	GPIO143	GPIO160
GPIO144	F17	GPIO144	GPIO161
GPIO145	E17	GPIO145/EPWM1A	GPIO162
GPIO146	D18	GPIO146/EPWM1B	GPIO163
GPIO147	D17	GPIO147/EPWM2A	GPIO164
GPIO148	D14	GPIO148/EPWM2B	GPIO165
GPIO149	A13	GPIO149/EPWM3A	GPIO166
GPIO150	B13	GPIO150/EPWM3B	GPIO167
GPIO151	C13	GPIO151/EPWM4A	GPIO168
GPIO152	D13	GPIO152/EPWM4B	
TMS20F28379QWTT			

Figure 9. P08_F28379D-IO1



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Figure 10. P09_F28379_IO2



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Figure 11. P10_EX-Headers

6.3 PCB Layout

Figure 12 through Figure 21 show the LAUNCHXL-F28379D Rev 2.0 PCB layout. The gerber files and PCB layout for both LAUNCHXL-F28379D Revision 2.0 and Revision 1.1 can be found in C2000Ware.

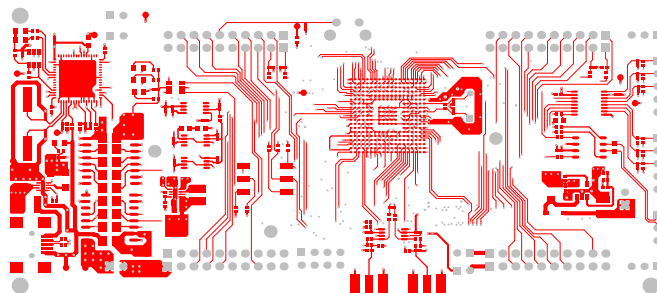


Figure 12. Top

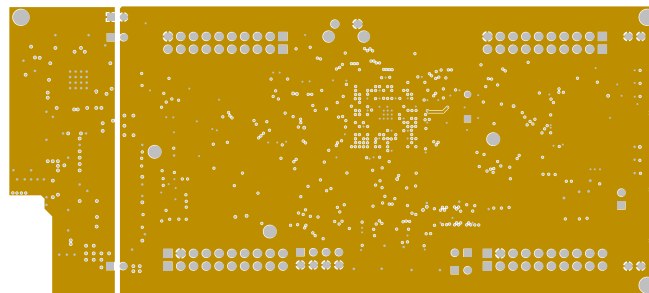


Figure 13. GND

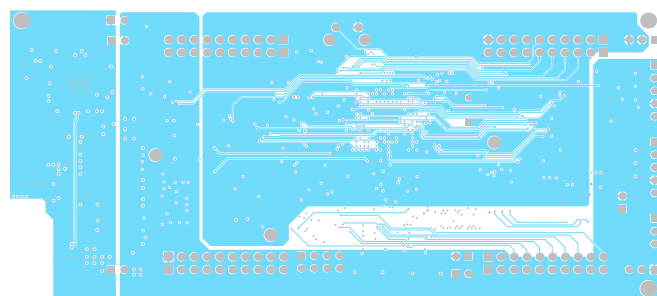


Figure 14. Route1

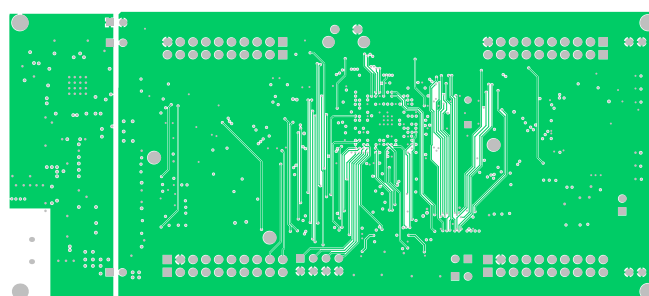


Figure 15. Route2

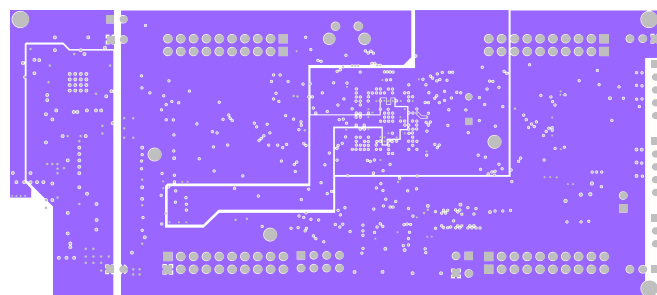


Figure 16. VDD

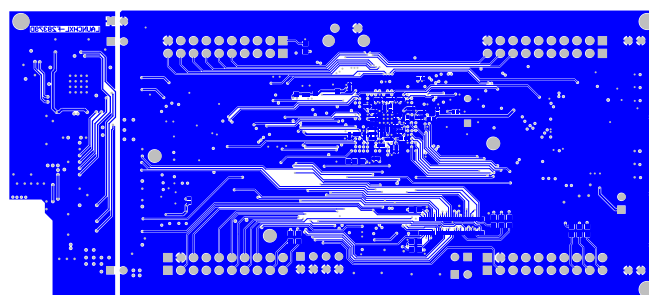


Figure 17. Bottom

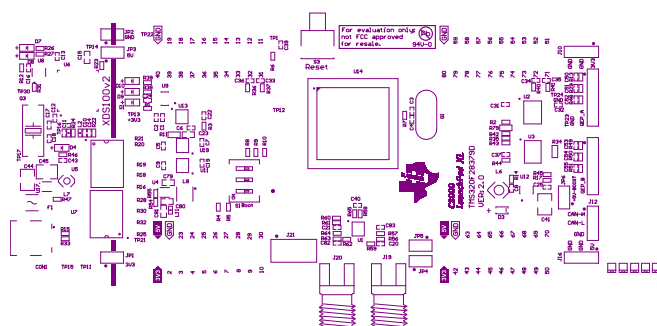


Figure 18. Top Silkscreen Overlay

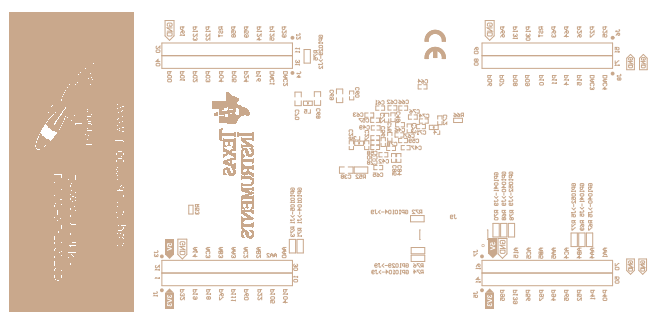


Figure 19. Bottom Silkscreen Overlay

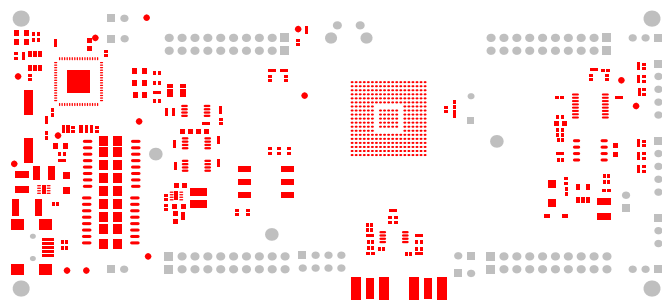


Figure 20. Top Pad Master

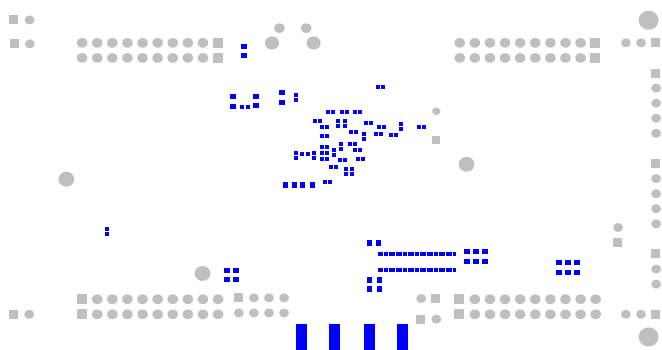


Figure 21. Bottom Pad Master

6.4 Bill of Materials (BOM)

Table 9 lists the LAUNCHXL-F28379D bill of materials.

Table 9. LAUNCHXL-F28379D Bill of Materials

Item #	Note	Part Number	Qty	REF Desig nator	Manufacturer (Digi-Key)	Description	ROHS (Digi-Key)	Lead Free Status	Reach Status (Digi-Key)	Reach Effective Date (Digi-Key)	Availability	Description (Digi-Key)	Manufacturer Part Number Digi-Key)	Digi-Key Part Number (Digi-Key)
1	PCB	LAUNCHXL-F28379D PCB rev2.0	1	PCB		6 layers,red soldermask,white silkscreen,130*59mm, ENIG,Launchxl-F28379D Rev2.0 pcb								
2	MCU	TMS320F28379DZ WTT	1	U14	Texas Instruments	IC, MCU 32BIT 1024KB,TMS320F28379 DZWTT, BGA-337,SMD,customer supply	YES	Lead Free	Reach Not Affected	Jun-2016	Non-Stock	IC MCU 32BIT 1MB FLASH 337NFBGA	TMS320F28379DZ WTT	TMS320F28379DZ WTT-ND
3	Memory	93LC56BT-I/OT	1	U8	Microchip Technology	IC,EEPROM Serial-Microwire 2K-Bit 128 x 16 2MHz,93LC56BT-I/OT,SOT-23-6,SMD	YES	Lead Free	Reach Not Affected	Jan-2017	Active	IC EEPROM 2KBIT 2MHZ SOT23-6	93LC56BT-I/OT	93LC56BT-I/OTCT-ND
4	Power Management	REF5030IDGKT	1	U13	Texas Instruments	IC 7V-Ref Precision 3V 10mA 8-Pin VSSOP T/R	YES	Lead Free	Reach Not Affected	Jun-2016	Active	IC VREF SERIES 3V 8VSSOP	REF5030IDGKT	296-24501-1-ND
5	DC-DC	LMR62421XMFE/N OPB	1	U12	Texas Instruments	Conv DC-DC Single Step Up 2.7V to 5.5V 5-Pin SOT-23 T/R ,CUSTOMER SUPPLY	YES	Lead Free	Reach Not Affected	Jun-2016	Active	IC REG BST SEPIC ADJ 2.1A SOT23	LMR62421XMFE/ NOPB	LMR62421XMFE/N OPBCT-ND
6	DC-DC	TPS62080ADSGT	1	U4	Texas Instruments	IC REG BUCK SYNC ADJ 1.2A 8WSON	YES	Lead Free	Reach Not Affected	Jun-2016	Active	IC REG BUCK ADJ 1.2A SYNC 8WSON	TPS62080ADSGT	296-30360-1-ND
7	DC-DC	TPS62162DSGT	1	U17	Texas Instruments	IC REG BUCK SYNC 3.3V 1A 8WSON	YES	Lead Free	Reach Not Affected	Jun-2016	Active	IC REG BUCK 3.3V 1A SYNC 8WSON	TPS62162DSGT	296-29897-1-ND
8	Amplifier	THS4531IDGKR	1	U1	Texas Instruments	IC OPAMP DIFF 27MHZ RRO 8VSSOP TR	YES	Lead Free	Reach Not Affected	Jun-2016	Active	IC OPAMP DIFF 27MHZ RRO 8VSSOP	THS4531IDGKR	296-30342-1-ND
9	Amplifier	OPA350EA/250	2	U11,U19	Texas Instruments	IC OPAMP GP 38MHZ RRO 8VSSOP T/R	YES	Lead Free	Reach Not Affected	Jun-2016	Active	IC OPAMP GP 38MHZ RRO 8VSSOP	OPA350EA/250	OPA350EACT-ND
10	Logic	TXB0106PWR	1	U2	Texas Instruments	IC, 6-bit bidirectional voltage-level translator with auto-direction sensing and ±15-kV ESD protection, TXB0106PWR, TSSOP-16, SMD,Cusomer Supply	YES	Lead Free	Reach Not Affected	Jun-2016	Active	IC 6BIT NON-INV TRANSLTR 16TSSOP	TXB0106PWR	296-23759-1-ND
11	Logic	SN74LVC2G07DBV R	1	U9	Texas Instruments	Buffer/Driver 2-CH Non-Inverting Open Drain CMOS 6-Pin SOT-23 T/R,CUSTOMER SUPPLY	YES	Lead Free	Reach Not Affected	Jun-2016	Active	IC BUFF/DVR DL NON-INV SOT23-6	SN74LVC2G07DBV R	296-13494-1-ND

Table 9. LAUNCHXL-F28379D Bill of Materials (continued)

Item #	Note	Part Number	Qty	REF Designator	Manufacturer (Digi-Key)	Description	ROHS (Digi-Key)	Lead Free Status	Reach Status (Digi-Key)	Reach Effective Date (Digi-Key)	Availability	Description (Digi-Key)	Manufacturer Part Number (Digi-Key)	Digi-Key Part Number (Digi-Key)
12	Interface	FT2232HQ-REEL	1	U6	FTDI, Future Technology Devices International Ltd	IC,Dual High Speed USB to Multipurpose UART/FIFO IC,FT2232HQ-REEL,QFN-64,SMD	YES	Lead Free	Reach Not Affected	Jan-2017	Active	IC USB HS DUAL UART/FIFO 64-QFN	FT2232HQ-REEL	768-1025-1-ND
13	Interface	SN65HVD234DR	1	U3	Texas Instruments	IC CAN transceiver 3.3V 8-SOIC	YES	Lead Free	Reach Not Affected	Jun-2016	Active	IC CAN TRANSCEIVER 3.3V 8-SOIC	SN65HVD234DR	296-27991-1-ND
14	Isolator	ISO7231CDWR	1	U7	Texas Instruments	IC DGTL ISO 3CH CMOS 16SOIC,CUSTOMER SUPPLY	YES	Lead Free	Reach Not Affected	Jun-2016	Active	DGTL ISO 2.5KV GEN PURP 16SOIC	ISO7231CDWR	296-38966-1-ND
15	Isolator	ISO7240CDWR	1	U5	Texas Instruments	IC DGTL ISO 4CH CMOS 16SOIC,CUSTOMER SUPPLY	YES	Lead Free	Reach Not Affected	Jun-2016	Active	DGTL ISO 2.5KV GEN PURP 16SOIC	ISO7240CDWR	296-38555-1-ND
16	Thick film Resistor	RC0402JR-070RL	4	R15, R33, R43, R44	Yageo	RES,0R,±5%,1/16W, SMD0402	YES	Lead Free	Reach Not Affected	Dec-2015	Active	RES SMD 0.0Ω JUMPER 1/16W 0402	RC0402JR-070RL	311-0.0JRCT-ND
17	Thick film Resistor	RC0402FR-0749R9L	2	R59, R62	Yageo	RES,49R9,±1%,1/16W, SMD0402	YES	Lead Free	Reach Not Affected	Jan-2017	Active	RES SMD 49.9 Ω 1% 1/16W 0402	RC0402FR-0749R9L	311-49.9LRCT-ND
18	Thick film Resistor	RC0402FR-071KL	13	R3,R13, R22, R23, R29, R36, R37, R40, R41, R48, R49, R50, R51	Yageo	RES,1K,±1%,1/16W, SMD0402	YES	Lead Free	Reach Not Affected	Jan-2017	Active	RES SMD 1K Ω 1% 1/16W 0402	RC0402FR-071KL	311-1.00KLRCT-ND
19	Thick film Resistor	RC0402FR-072KL	4	R56, R57, R63, R64	Yageo	RES,2K,±1%,1/16W, SMD0402	YES	Lead Free	Reach Not Affected	Jan-2017	Active	RES SMD 2K Ω 1% 1/16W 0402	RC0402FR-072KL	311-2KLRCT-ND
20	Thick film Resistor	RC0402FR-072K2L	6	R2, R6, R8, R9, R10, R31	Yageo	RES,2K2,±1%,1/16W, SMD0402	YES	Lead Free	Reach Not Affected	Jan-2017	Active	RES SMD 2.2K Ω 1% 1/16W 0402	RC0402FR-072K2L	311-2.20KLRCT-ND
21	Thick film Resistor	RC0402FR-0710KL	7	R12, R14, R35, R42, R45,R60, R61	Yageo	RES,10K,±1%,1/16W, SMD0402	YES	Lead Free	Reach Not Affected	Jan-2017	Active	RES SMD 10K Ω 1% 1/16W 0402	RC0402FR-0710KL	311-10.0KLRCT-ND
22	Thick film Resistor	RC0402FR-0712KL	1	R24	Yageo	RES,12K,±1%,1/16W, SMD0402	YES	Lead Free	Reach Not Affected	Jan-2017	Active	RES SMD 12K Ω 1% 1/16W 0402	RC0402FR-0712KL	311-12.0KLRCT-ND
23	Thick film Resistor	RC0402FR-0730K1L	1	R17	Yageo	RES,30K1,±1%,1/16W, SMD0402	YES	Lead Free	Reach Not Affected	Jan-2017	Active	RES SMD 30.1K Ω 1% 1/16W 0402	RC0402FR-0730K1L	311-30.1KLRCT-ND
24	Thick film Resistor	RC0402FR-0739K2L	1	R55	Yageo	RES,39K2,±1%,1/16W, SMD0402	YES	Lead Free	Reach Not Affected	Jan-2017	Active	RES SMD 39.2K Ω 1% 1/16W 0402	RC0402FR-0739K2L	311-39.2KLRCT-ND
25	Thick film Resistor	RC0402FR-07100KL	1	R47	Yageo	RES,100K,±1%,1/16W, SMD0402	YES	Lead Free	Reach Not Affected	Jan-2017	Active	RES SMD 100K Ω 1% 1/16W 0402	RC0402FR-07100KL	311-100KLRCT-ND

Table 9. LAUNCHXL-F28379D Bill of Materials (continued)

Item #	Note	Part Number	Qty	REF Designator	Manufacturer (Digi-Key)	Description	ROHS (Digi-Key)	Lead Free Status	Reach Status (Digi-Key)	Reach Effective Date (Digi-Key)	Availability	Description (Digi-Key)	Manufacturer Part Number (Digi-Key)	Digi-Key Part Number (Digi-Key)
26	Thick film Resistor	RC0402FR-071ML	1	R7	Yageo	RES,1M,±1%,1/16W, SMD0402	YES	Lead Free	Reach Not Affected	Jan-2017	Active	RES SMD 1M Ω 1% 1/16W 0402	RC0402FR-071ML	311-1.00MLRCT-ND
27	Thick film Resistor	RC0603JR-070RL	6	R67,R69, R71,R73, R75,R77	Yageo	RES,0R,±5%,1/10W, SMD0603	YES	Lead Free	Reach Not Affected	Dec-2015	Active	RES SMD 0.0Ω JUMPER 1/10W 0603	RC0603JR-070RL	311-0.0GRCT-ND
28	Thick film Resistor	RL0603FR-070R1L	2	R11,R52	Yageo	RES,0R1.±1%,1/10W, SMD0603	YES	Lead Free	Reach Not Affected	Jan-2017	Active	RES SMD 0.1 Ω 1% 1/10W 0603	RL0603FR-070R1L	311-1.10QCT-ND
29	Thick film Resistor	RC0603FR-07120RL	1	R34	Yageo	RES,120R,±1%,1/10W, SMD0603	YES	Lead Free	Reach Not Affected	Jan-2017	Active	RES SMD 120 Ω 1% 1/10W 0603	RC0603FR-07120RL	311-120HRCT-ND
30	Thick film Resistor	RC0402FR-07820RL	2	R4, R5	Yageo	RES,820R,±1%,1/16W, SMD0402	YES	Lead Free	Reach Not Affected	Jan-2017	Active	RES SMD 820 Ω 1% 1/16W 0402	RC0402FR-07820RL	311-820LRCT-ND
31	Thick film Resistor	RC0402FR-07680RL	6	R1,R26,R 27,R38,R 39, R46	Yageo	RES,680R,±1%,1/16W, SMD0402	YES	Lead Free	Reach Not Affected	Jan-2017	Active	RES SMD 680 Ω 1% 1/16W 0402	RC0402FR-07680RL	311-680LRCT-ND
32	Thick film Resistor	ERJ-2RKF1783X	1	R53	Panasonic Electronic Components	RES, 178K Ω, 1%, 1/10W, SMD0402	YES	Lead Free	Reach Not Affected	Jan-2017	Active	RES SMD 178K Ω 1% 1/10W 0402	ERJ-2RKF1783X	P178KLCT-ND
33	Thick film Resistor	ERJ-2RKF6492X	1	R54	Panasonic Electronic Components	RES, 64.9K Ω, 1%, 1/10W, SMD0402	YES	Lead Free	Reach Not Affected	Jan-2017	Active	RES SMD 64.9K Ω 1% 1/10W 0402	ERJ-2RKF6492X	P64.9KLCT-ND
34	Thick film Resistor	CRCW040212R0JN ED	2	R58, R65	Vishay Dale	RES SMD 12 Ω 5% 1/16W 0402 TR	YES	Lead Free	Reach Not Affected	Dec-2015	Active	RES SMD 12 Ω 5% 1/16W 0402	CRCW040212R0JN ED	541-12JCT-ND
35	Ceramic Capacitor	GRM1555C1H101J A01D	2	C20, C82	Murata Electronics North America	CAP,100PF,±5%,C0G, 50V,SMD0402	YES	Lead Free	Reach Not Affected	Jun-2016	Active	CAP CER 100PF 50V C0G/NP0 0402	GRM1555C1H101J A01D	490-5922-1-ND
36	Ceramic Capacitor	GRM1555C1H181J A01D	1	C40	Murata Electronics North America	CAP,180PF,±5%,C0G, 50V,SMD0402	YES	Lead Free	Reach Not Affected	Jun-2016	Active	CAP CER 180PF 50V C0G/NP0 0402	GRM1555C1H181J A01D	490-3231-1-ND
37	Ceramic Capacitor	GRM1555C1H821J A01D	1	C25	Murata Electronics North America	CAP,820PF,±5%,C0G, 50V,SMD0402	YES	Lead Free	Reach Not Affected	Jun-2016	Active	CAP CER 820PF 50V C0G/NP0 0402	GRM1555C1H821J A01D	490-3242-1-ND
38	Ceramic Capacitor	GRM155R71H102K A01D	6	C50, C51, C52, C53, C54, C55	Murata Electronics North America	CAP,1NF,±10%,X7R, 50V,SMD0402	YES	Lead Free	Reach Not Affected	Jun-2016	Active	CAP CER 1000PF 50V X7R 0402	GRM155R71H102K A01D	490-1303-1-ND
39	Ceramic Capacitor	GRM155R61A224K E19D	1	C83	Murata Electronics North America	CAP,220NF,±10%,X5R, 10V,SMD0402	YES	Lead Free	Reach Not Affected	Jun-2016	Active	CAP CER 0.22UF 10V X5R 0402	GRM155R61A224K E19D	490-3910-1-ND
40	Ceramic Capacitor	GRM155R60J105K E19D	5	C6, C7, C19, C21,C22	Murata Electronics North America	CAP,1UF,±10%,X5R,6.3 V,SMD0402 ?suffix J stand for 330mm reel ?	YES	Lead Free	Reach Not Affected	Jun-2016	Active	CAP CER 1UF 6.3V X5R 0402	GRM155R60J105K E19D	490-1320-1-ND

Table 9. LAUNCHXL-F28379D Bill of Materials (continued)

Item #	Note	Part Number	Qty	REF Designator	Manufacturer (Digi-Key)	Description	ROHS (Digi-Key)	Lead Free Status	Reach Status (Digi-Key)	Reach Effective Date (Digi-Key)	Availability	Description (Digi-Key)	Manufacturer Part Number (Digi-Key)	Digi-Key Part Number (Digi-Key)
41	Ceramic Capacitor	GRM155R60J225M E15D	14	C2, C27, C29, C42, C46, C47, C48, C49, C71, C72, C75, C76, C77, C78	Murata Electronics North America	CAP,2.2UF,±20%,X5R, 6.3V,SMD0402	YES	Lead Free	Reach Not Affected	Jun-2016	Active	CAP CER 2.2µF 6.3V X5R 0402	GRM155R60J225M E15D	490-4519-1-ND
42	Ceramic Capacitor	GRM188R60J106M E47D	5	C68, C69, C70, C79, C81	Murata Electronics North America	CAP,10UF,±20%,X5R, 6.3V,SMD0603	YES	Lead Free	Reach Not Affected	Jun-2016	Active	CAP CER 10µF 6.3V X5R 0603	GRM188R60J106M E47D	490-3896-1-ND
43	Ceramic Capacitor	GRM188R60J226M EA0D	3	C23,C38, C80	Murata Electronics North America	CAP,22UF,±20%,X5R, 6.3V,SMD0603	YES	Lead Free	Reach Not Affected	Jun-2016	Active	CAP CER 22µF 6.3V X5R 0603	GRM188R60J226M EA0D	490-7611-1-ND
44	Ceramic Capacitor	GRM32DR71E106K A12L	2	C41, C44	Murata Electronics North America	CAP,10UF,±10%,X7R, 25V,SMD1210	YES	Lead Free	Reach Not Affected	Jun-2016	Active	CAP CER 10µF 25V X7R 1210	GRM32DR71E106K A12L	490-1867-1-ND
45	Ceramic Capacitor	GRM155R61A104K A01D	35	C1, C5, C9, C12, C13, C14, C16, C24, C28, C30, C31, C32, C33, C34, C35, C36, C37, C39, C43, C56, C57, C58, C59, C60, C61, C62, C63, C64, C65, C66, C67, C73, C74,C84, C85	Murata Electronics North America	CAP,100NF(0.1uf),±10% ,X5R,10V,SMD0402	YES	Lead Free	Reach Not Affected	Jun-2016	Active	CAP CER 0.1µF 10V X5R 0402	GRM155R61A104K A01D	490-1318-1-ND
46	Ceramic Capacitor	GRM32ER61E226K E15L	1	C45	Murata Electronics North America	CAP,22UF,±10%,X5R, 25V,SMD1210	YES	Lead Free	Reach Not Affected	Jun-2016	Active	CAP CER 22µF 25V X5R 1210	GRM32ER61E226K E15L	490-3889-1-ND
47	Ceramic Capacitor	GRM155R60J475M E47D	3	C8, C10, C11	Murata Electronics North America	CAP,4.7UF,±20%,X5R, 6.3V,SMD0402 fix PN add D?20151023?	YES	Lead Free	Reach Not Affected	Jun-2016	Active	CAP CER 4.7µF 6.3V X5R 0402	GRM155R60J475M E47D	490-5915-1-ND
48	Ceramic Capacitor	GRM188R61A335K E15D	1	C15	Murata Electronics North America	CAP,3.3uF,±10%,X5R, 10V,SMD0603	YES	Lead Free	Reach Not Affected	Jun-2016	Active	CAP CER 3.3µF 10V X5R 0603	GRM188R61A335K E15D	490-6411-1-ND
49	Ceramic Capacitor	GRM1555C1H360J A01D	4	C3,C4,C17,C18	Murata Electronics North America	CAP,36pF,±5%,C0G,50V ,SMD0402	YES	Lead Free	Reach Not Affected	Jun-2016	Active	CAP CER 36PF 50V C0G/NP0 0402	GRM1555C1H360J A01D	490-5937-1-ND
50	Inductor	LQH3NPN1R0NJ0L	1	L8	Murata Electronics North America	FIXED IND 1µH 1.62A 40 MΩ SMD,±30%	YES	Lead Free	Reach Not Affected	Jun-2016	Active	FIXED IND 1µH 1.62A 40 MΩ SMD	LQH3NPN1R0NJ0L	490-5342-1-ND
51	Inductor	CDRH2D18/HPNP-2R2NC	1	L7	Sumida America Components Inc.	Power inductor,magnetic shielded,2.2µH,1.6A,0.06 Ω,3.0X3.0X1.8mm,SMD	YES	Lead Free	Reach Not Affected	Jun-2016	Active	FIXED IND 2.2µH 1.9A 60 MΩ SMD	CDRH2D18/HPNP-2R2NC	308-2295-2-ND

Table 9. LAUNCHXL-F28379D Bill of Materials (continued)

Item #	Note	Part Number	Qty	REF Designator	Manufacturer (Digi-Key)	Description	ROHS (Digi-Key)	Lead Free Status	Reach Status (Digi-Key)	Reach Effective Date (Digi-Key)	Availability	Description (Digi-Key)	Manufacturer Part Number (Digi-Key)	Digi-Key Part Number (Digi-Key)
52	Inductor	CDRH3D16/HPNP-3R3NC	1	L6	Sumida America Components Inc.	Power Inductor,Magnetic shielded,3.3μH,1.4A,0.085Ω,3.8X3.8X1.6mm,SMD	YES	Lead Free	Reach Not Affected	Jun-2016	Non-Stock	FIXED IND 3.3μH 1.8A 85 MΩ SMD	CDRH3D16/HPNP-3R3NC	308-1981-1-ND
53	Ferrite Bead	BLM15AG601SN1D	2	L1, L2	Murata Electronics North America	Ferrite Bead,600Ω@100MHz,±25%,300mA,0.6Ω,SMD0402	YES	Lead Free	Reach Not Affected	Jun-2016	Active	FERRITE BEAD 600 Ω 0402 1LN	BLM15AG601SN1D	490-1006-1-ND
54	Ferrite Bead	BLM15PD600SN1D	2	L3, L4	Murata Electronics North America	Ferrite Bead,60Ω@100MHz,±25%,1700mA,0.06Ω,SMD0402	YES	Lead Free	Reach Not Affected	Jun-2016	Active	FERRITE BEAD 60 Ω 0402 1LN	BLM15PD600SN1D	490-5201-1-ND
55	Ferrite Bead	BKP1005EM221-T	2	L5, L11	Taiyo Yuden	FERRITE BEAD 220 Ω 0402,±25%	YES	Lead Free	Reach Not Affected	Jun-2016	Active	FERRITE BEAD 220 Ω 0402 1LN	BKP1005EM221-T	587-3290-1-ND
56	LED	150080VS75000	2	D1, D4	Würth Electronics Inc.	LED, Bright GREEN , 570nm,20mA,SMD,0805	YES	Lead Free	Reach Not Affected	Jan-2017	Active	LED GREEN CLEAR 0805 SMD	150080VS75000	732-4986-1-ND
57	LED	150080BS75000	2	D7, D10	Würth Electronics Inc.	LED, BLUE ,470NM, 20mA,SMD,0805	YES	Lead Free	Reach Not Affected	Jan-2017	Active	LED BLUE CLEAR 0805 SMD	150080BS75000	732-4982-1-ND
58	LED	150080SS75000	2	D8, D9	Würth Electronics Inc.	LED, SUPPER RED ,630NM,20mA,SMD,0805	YES	Lead Free	Reach Not Affected	Jan-2017	Active	LED RED CLEAR 0805 SMD	150080SS75000	732-4985-1-ND
59	Diode	1N5819HW-7-F	1	D3	Diodes Incorporated	Diode,Schottky Diode,1N5819HW-7-F,40V,1A,SOD-123,SMD,-65~125,TR	YES	Lead Free	Reach Not Affected	Jan-2017	Active	DIODE SCHOTTKY 40V 1A SOD123	1N5819HW-7-F	1N5819HW-FDICT-ND
60	Polyswitch	MF-MSMF050-2	1	F1	Bourns Inc.	PTC RESETTABLE .50A 15V 1812	YES	Lead Free	Reach Not Affected	Jan-2017	Active	PTC RESETTABLE .50A 15V 1812	MF-MSMF050-2	MF-MSMF050-2CT-ND
61	Crystal	ABLS2-12.000MHZ-D4Y-T	1	Q3	Abracon LLC	Crystal 12MHz ±30ppm (Tol) ±30ppm (Stability) 18pF FUND 50Ω 2-Pin HC-49/US SMD T/R	YES	Lead Free	REACH AFFECTED	Jan-2017	Active	CRYSTAL 12.0000MHZ 18PF SMD	ABLS2-12.000MHZ-D4Y-T	535-9869-1-ND
62	Crystal	ATS100B-E	1	Q1	CTS-Frequency Controls	Crystal 10.0000MHz 30ppm 18pF 60 Ω -40°C - 85°C Through Hole HC49/US	YES	Lead Free	Reach Not Affected	Jan-2017	Active	CRYSTAL 10.0000MHZ 18PF T/H	ATS100B-E	CTX919-ND
63	Pin Header	P6E02A-602530-B1	6	JP1, JP2, JP3, JP4, JP5, JP6		Connector,Pin Header,Straight,Male,1x 2Pin,2.54MM pitch,6.00,3.00,Gold Flash 1u, black,DIP,alt_code:15071705								
64	Pin Header	P6E03A-602530-B1	3	J10,J12,J16		Connector,Pin Header,Straight,Male,1x 3Pin,2.54MM pitch,6.00,3.00,Gold Flash 1u, black,DIP,alt_code:15071706								

Table 9. LAUNCHXL-F28379D Bill of Materials (continued)

Item #	Note	Part Number	Qty	REF Designator	Manufacturer (Digi-Key)	Description	ROHS (Digi-Key)	Lead Free Status	Reach Status (Digi-Key)	Reach Effective Date (Digi-Key)	Availability	Description (Digi-Key)	Manufacturer Part Number (Digi-Key)	Digi-Key Part Number (Digi-Key)
65	Pin Header	P101-1*05SGF-116A-NX	2	QEP_A, QEP_B		Connector,Pin Header,Straight,Male,1x5Pin,2.54MM pitch,6.06,3.00,Gold Flash 1u, black,DIP								
66	Pin Header	P101-2*04SGF-116A-NX	1	J21		Connector,Pin Header,Straight,Male,2x4Pin,2.54MM pitch,6.06,3.00,Gold Flash 1u, black,DIP								
67	Pin Socket	CRD-081413-A-G	4	(J1,J3),(J2?J4),(J5?J7),(J6?J8)		Connector,Pin Socket,Straight,Female,2x10Pin,2.54MM pitch,8.51,9.91,Gold Flash 10u, black,DIP upgrade MPN. old part->CRD-081413-G-A								
68	USB Connector	897-43-005-00-100001	1	CON1	Mill-Max Manufacturing Corp.	Connector,MiniUSB B port,5 position,Right Angle,Gold flash 30u,black,SMD	YES	Lead Free	Reach Not Affected	Jan-2017	Active	CONN RECEPT MINI-USB TYPE B SMT	897-43-005-00-100001	ED90341CT-ND
69	BTB Connector	DF40C-60DP-0.4V(51)	1	J9	Hirose Electric Co Ltd	CONN HDR 60POS 0.4MM SMD GOLD TR	YES	Lead Free	Reach Not Affected	Dec-2015	Active	CONN HDR 60POS 0.4MM SMD GOLD	DF40C-60DP-0.4V(51)	H11628CT-ND
70	Shunt	MJ501-EOGF-B-K	5	JP1,JP2,J P3,JP4,J P5		Connector,Shunt,open type 2Pin,2.54MM Pitch,6MM Height,Gold Flash 1u,black,Bulk								
71	Tactile Switch	B3F-3152	1	S3	Omron Electronics Inc-EMC Div	SWITCH TACTILE SPST-NO 0.05A 24V	YES	Lead Free	Reach Not Affected	Dec-2015	Active	SWITCH TACTILE SPST-NO 0.05A 24V	B3F-3152	SW410-ND
72	DIP Switch	219-3MST	1	S1	CTS Electrocomponents	Switch, DIP Switches,3 Position,2.54MM Pitch,black housing,white plunger,SMD	YES	Lead Free	Reach Not Affected	Jun-2016	Active	SWITCH SLIDE DIP SPST 100MA 20V	219-3MST	CT2193MST-ND

7 References

The following documents describe the C2000 devices. Copies of these documents are available on the Internet at <http://www.ti.com/c2000> and www.ti.com/c2000-launchpad, or click on the links below:

1. *TMS320F2837xD Dual-Core Delfino™ Microcontrollers Data Manual* ([SPRS880](#))
2. *TMS320F28379D, TMS320F28377D, TMS320F28376D, TMS320F28375D, TMS320F28374D Delfino Microcontrollers Silicon Errata* ([SPRZ412](#))
3. *TMS320F2837xD Dual-Core Delfino Microcontrollers Technical Reference Guide* ([SPRUHM8](#))
4. *TMS320C28x Extended Instruction Sets Technical Reference Manual* ([SPRUHS1](#))
5. *TMS320C28x Instruction Set Simulator Technical Overview* ([SPRU608](#))
6. *TMS320C28x Optimizing C/C++ Compiler v6.1 User's Guide* ([SPRU514](#))
7. *TMS320C28x Assembly Language Tools v6.1 User's Guide* ([SPRU513](#))

8 Frequently Asked Questions (FAQ)

1. Can other programming and debug tools (such as an XDS510 emulator) be used with the C2000 LaunchPad?

While a user could potentially connect an external emulator to the F28379D device present on the LaunchPad, it would require some rework of the board. It is recommended that users who want to use an external emulator purchase a controlCard and docking station that includes an external JTAG connector.

2. What versions of Code Composer Studio can be used to develop software for the C2000 LaunchPad?

It is highly recommend that novice users develop applications with at least Code Composer Studio v6. The drivers, examples, and other associated software are tailored to make the user experience as smooth as possible in Code Composer Studio v6.

3. Why can't I connect to the LaunchPad in Code Composer Studio?

There are a number of things that could cause this and they all have an easy fix.

- Is S1 switch 3 in the down position?

This is the TRST pin that enables and disables JTAG functionality on the chip. This switch must be in the up position for the emulator to be able to connect.

- Are both power LEDs lit?

The board has two power domains because of the isolated JTAG interface. For low-voltage application development, JTAG isolation is not needed and the power domains can be combined to allow for convenience (that is, the board can be powered completely through the USB). Ensure that jumpers are placed on the posts of JP1 and JP2.

- Are drivers correctly installed for the XDS100v2 present on the LaunchPad?

Right click on *My Computer* and select properties. Navigate to the *Hardware* tab in the dialog box and open the device manager. Scroll to the bottom of the list and expand the *USB Serial Bus controllers* item. Are there two entries for *TI XDS100 Channel A/B*? If not, try unplugging and replugging in the board. Does Windows give you any messages in the system tray? In Device Manger, do either of the entries have a yellow exclamation mark over their icon? If so, try reinstalling the drivers.

4. Why is the serial connection not working?

- Are you using the correct COM port?

Right click on *My Computer* and select properties. Navigate to the *Hardware* tab in the dialog box and open the device manager. Scroll to *Ports (COM & LPT)* and expand this entry. Is there a USB Serial Port listed? If so, read the COM number to the right of the entry; this is the COM number you should be using.

- Are you using the correct baud rate?

Most, if not all, of the examples are configured for a baud rate of 115200 when the CPU is running at 200 MHz. If you have changed the PLL settings or written your own application you may have to recalculate the baud rate for your specific application. For information on how to do this, see the [TMS320F2837xD Delfino Microcontrollers Technical Reference Guide](#).

Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from A Revision (August 2017) to B Revision	Page
• Update was made in Section 2.1	3
• Table 8 : Changed Mux Values ePWM1A and ePWM1B to ePWM2A and ePWM2B.	9

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